# 

Data sheet acquired from Harris Semiconductor SCHS071B – Revised July 2003

# CMOS Presettable Up/Down Counters

High-Voltage Types (20-Volt Rating) CD4510B - - - BCD Type

CD4516B --- Binary Type

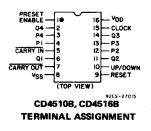
■ CD4510B Presettable BCD Up/Down Counter and the CD4516 Presettable Binary Up/Down Counter consist of four synchronously clocked D-type flip-flops (with a gating structure to provide T-type flip-flop capability) connected as counters. These counters can be cleared by a high level on the RESET line, and can be preset to any binary number present on the jam inputs by a high level on the PRESET ENABLE line. The CD4510B will count out of non-BCD counter states in a maximum of two clock pulses in the up mode, and a maximum of four clock pulses in the down mode.

If the CARRY-IN input is held low, the counter advances up or down on each positive-going clock transition. Synchronous cascading is accomplished by connecting all clock inputs in parallel and connecting the CARRY-OUT of a less significant stage to the CARRY-IN of a more significant stage.

The CD4510B and CD4516B can be cascaded in the ripple mode by connecting the CARRY-OUT to the clock of the next stage. If the UP/DOWN input changes during a terminal count, the CARRY-OUT must be gated with the clock, and the UP/DOWN input must change while the clock is high. This method provides a clean clock signal to the subsequent counting stage. (See Fig. 15).

# These devices are similar to types MC14510 and MC14516.

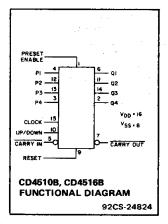
The CD4510B and CD4516B types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4516B types also are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix).



# CD4510B, CD4516B Types

#### Features:

- Medium-speed operation -f<sub>CL</sub> = 8 MHz typ. at 10 V
- Synchronous internal carry propagation
- Reset and Preset capability
- I00% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Standardized symmetrical output characteristics
- Maximum input current of 1 μA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range): 1 V at V<sub>DD</sub> = 5 V
  2 V at V<sub>DD</sub> = 10 V
  - 2.5 V at  $V_{DD} = 15 V$
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"



#### Applications:

- Up/Down difference counting
- Multistage synchronous counting
- Multistage ripple counting
- Synchronous frequency dividers

#### OPERATING CONDITIONS AT T<sub>A</sub> = 25°C, Unless Otherwise Specified

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

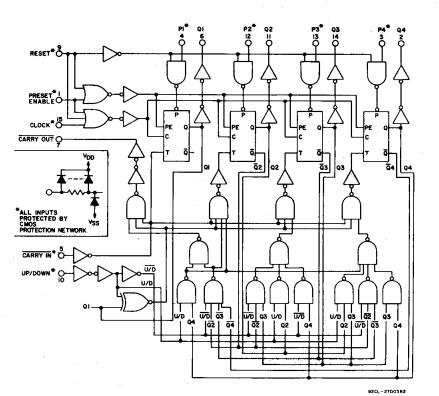
| Characteristic                                                            | V <sub>DD</sub>                                       | Min.                                                                 | Max.                                                               | Units |
|---------------------------------------------------------------------------|-------------------------------------------------------|----------------------------------------------------------------------|--------------------------------------------------------------------|-------|
| Supply Voltage Range (At T <sub>A</sub> = Full Package-Temperature Range) |                                                       | 3                                                                    | 18                                                                 | v     |
|                                                                           | 5                                                     | 150                                                                  | -                                                                  |       |
| Clock Pulse Width, t <sub>W</sub>                                         | 10                                                    | 75                                                                   | -                                                                  | ns    |
|                                                                           | 15                                                    | 3 11<br>150<br>75<br>60<br>-<br>-<br>5.<br>150<br>80<br>60<br>-<br>1 | -                                                                  |       |
|                                                                           | 5                                                     | -                                                                    | 2                                                                  |       |
| Clock Input Frequency, f <sub>CL</sub>                                    |                                                       | -                                                                    | 4                                                                  | MHz   |
|                                                                           | 15                                                    | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$                | 5.5                                                                |       |
|                                                                           | 5                                                     | 150                                                                  | _                                                                  |       |
| Preset Enable or Reset Removal Time <sup>®</sup>                          | 10                                                    | 80                                                                   | -                                                                  | ns    |
|                                                                           | 15                                                    | 80<br>60<br>- 1<br>- 1                                               | -                                                                  |       |
|                                                                           | 5                                                     | -                                                                    | 15                                                                 |       |
| Clock Rise and Fall Time, trCL, trCL*                                     | 10                                                    | -                                                                    | 5                                                                  | μs    |
|                                                                           | 5                                                     | 130                                                                  |                                                                    |       |
| Carry-In Setup Time, t <sub>S</sub>                                       | 10                                                    | 60                                                                   | _                                                                  | ns    |
|                                                                           | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | _                                                                    |                                                                    |       |
|                                                                           | 5                                                     | 360                                                                  |                                                                    |       |
| Up-Down Setup Time, t <sub>S</sub>                                        | 10                                                    | 160                                                                  | _                                                                  | ns    |
|                                                                           | 15                                                    | 110                                                                  | ) -<br>) -<br>) -<br>) -<br>) -<br>) -<br>) -<br>) -<br>) -<br>) - |       |
|                                                                           | 5                                                     | 220                                                                  | _                                                                  |       |
| Preset Enable or Reset Pulse Width, tw                                    | 10                                                    | 100                                                                  |                                                                    | ns    |
|                                                                           | 15                                                    | 75                                                                   |                                                                    |       |

•Time required after the falling edge of the reset or preset enable inputs before the rising edge of the clock will trigger the counter (similar to setup time).

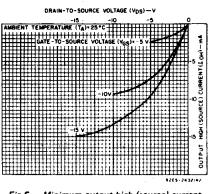
\*If more than one unit is cascaded in the parallel clocked application, trCL should be made less than or equal to the sum of the fixed propagation delay at 15 pF and the transition time of the carry output driving stage for the estimated capacitive load.

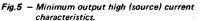
CD4510B Types

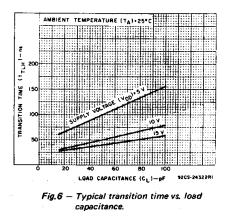
| MAXIMUM RATINGS, Absolute-Maximum Values:                                                                        |                                                     |
|------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------|
| DC SUPPLY-VOLTAGE RANGE, (VDD)                                                                                   |                                                     |
| Voltages referenced to V <sub>SS</sub> Terminal)                                                                 | 0.5V to +20V                                        |
| INPUT VOLTAGE RANGE, ALL INPUTS                                                                                  | 0.5V to V <sub>DD</sub> +0.5V                       |
| DC INPUT CURRENT, ANY ONE INPUT                                                                                  | ±10mA                                               |
| POWER DISSIPATION PER PACKAGE (PD):                                                                              |                                                     |
| For T <sub>A</sub> = -55°C to +100°C                                                                             |                                                     |
| For T <sub>A</sub> = +100 <sup>o</sup> C to +125 <sup>o</sup> C                                                  | . Derate Linearity at 12mW/ <sup>0</sup> C to 200mW |
|                                                                                                                  |                                                     |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR                                                                         | 100mW                                               |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR<br>FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Packag               | je i ypesj                                          |
|                                                                                                                  |                                                     |
| FOR T <sub>A</sub> = FULL PACKAGE-TEMPERATURE RANGE (All Packag<br>OPERATING-TEMPERATURE RANGE (T <sub>A</sub> ) |                                                     |
| FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Packag                                                              |                                                     |

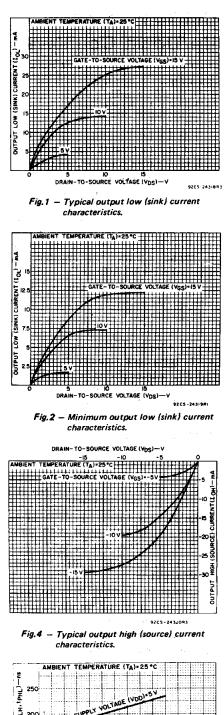


#### Fig.3 - Logic Diagram for CD4510B.

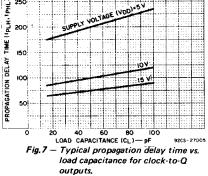








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#### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-                | COND     | DITIO | IS  | LIMI        | TS AT I | NDICAT | ED TEN | <b>IPERA</b> | TURES             | (°C) | UNITS |
|---------------------------|----------|-------|-----|-------------|---------|--------|--------|--------------|-------------------|------|-------|
| ISTIC                     | Vo       | VIN   | VDD |             |         |        |        | +25          |                   |      |       |
|                           | (V)      | (V)   | (v) | -55         | -40     | +85    | +125   | Min.         | Тур.              | Max. |       |
| Quiescent Device          | -        | 0,5   | 5   | 5           | 5       | 150    | 150    | -            | 0.04              | 5    |       |
| Current,                  | -        | 0,10  | 10  | 10          | 10      | 300    | 300    | -            | .0.04             | 10   | μA    |
| IDD Max.                  | _        | 0,15  | 15  | 20          | 20      | 600    | 600    | -            | 0.04              | 20   | μΑ    |
|                           | -        | 0,20  | 20  | -100        | 100     | 3000   | 3000   | -            | 0.08              | 100  |       |
| Output Low                | 0.4      | 0,5   | 5   | 0.64        | 0.61    | 0.42   | 0.36   | 0.51         | 1                 | -    |       |
| (Sink) Current            | 0,5      | 0,10  | 10  | 1.6         | 1.5     | 1.1    | 0.9    | 1.3          | 2.6               | -    |       |
| IOL Min.                  | 1.5      | 0,15  | 15  | 4.2         | 4       | 2.8    | 2.4    | 3.4          | 6.8               | -    | 1     |
| Output High               | 4.6      | 0,5   | 5   | -0.64       | -0.61   | -0.42  | -0.36  | -0.51        | -1                | -    | mA    |
| (Source)                  | 2.5      | 0,5   | 5   | -2          | -1.8    | -1.3   | -1.15  | -1.6         | -3.2              | -    |       |
| Current,                  | 9,5      | 0,10  | 10  | -1.6        | ~1.5    | -1.1   | -0.9   | -1.3         | -2.6              | -    |       |
| IOH MIN                   | 13.5     | 0,15  | 15  | 4,2         | -4      | -2.8   | -2.4   | -3.4         | -6.8              | -    |       |
| Output Voltage:           | -        | 0,5   | 5   | 0.05 - 0 0. |         |        |        |              |                   | 0.05 |       |
| Low-Level,<br>VOL Max.    | -        | 0,10  | 10  |             | 0       | .05    |        | -            | 0                 | 0.05 |       |
|                           | _        | 0,15  | 15  |             | Ō       | .05    |        | -            | 0                 | 0.05 | v     |
| Output Voltage:           |          | 0,5   | 5   |             | 4       | .95    |        | 4.95         | 5                 | -    |       |
| High-Level,               | -        | 0,10  | 10  |             | 9       | .95    |        | 9,95         | 10                | -    |       |
| VOH Min.                  | -        | 0,15  | 15  |             | 14      | .95    |        | 14.95        | 15                | -    |       |
| Input Low                 | 0.5, 4.5 | -     | 5   |             | 1       | .5     |        | -            | -                 | 1.5  |       |
| Voltage,                  | 1, 9     | -     | 10  |             |         | 3      |        | -            | -                 | 3    |       |
| VIL Max.                  | 1.5,13.5 | -     | 15  |             |         | 4      |        | -            |                   | 4    | v     |
| Input High                | 0.5, 4.5 | -     | 5   |             | 3       | 3.5    |        | 3.5          |                   | _    | v     |
| Voltage,                  | 1, 9     | -     | 10  |             |         | 7      |        | 7            | -                 | -    |       |
| VIH Min.                  | 1.5,13.5 | -     | 15  |             |         | 11     |        | 11           | -                 | -    |       |
| Input Current<br>IIN Max. | _        | 0,18  | 18  | ±0.1        | ±0.1    | ±1     | ±1     | -            | ±10 <sup>-5</sup> | ±0.1 | μA    |

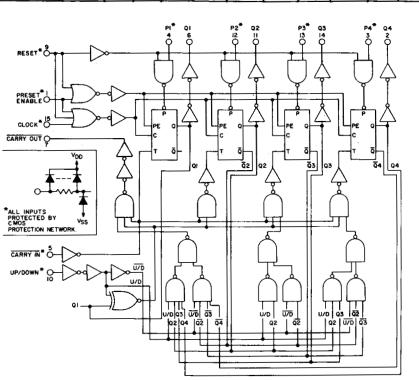
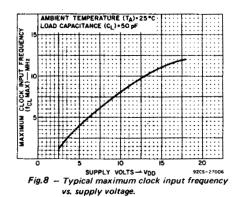
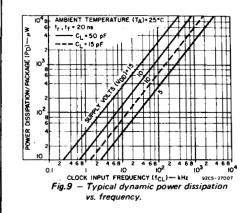


Fig. 16 - Logic Diagram for CD4516B.







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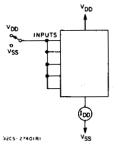


Fig. 11 - Quiescent-device-current test circuit.

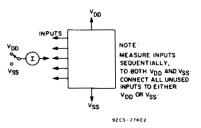


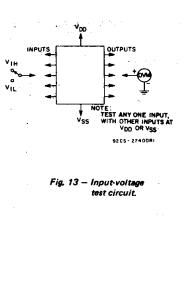
Fig. 12 – Input-current test circuit.

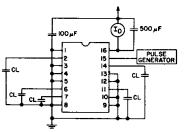
92CL - 2700482

## CD4510B Types

# DYNAMIC ELECTRICAL CHARACTERISTICS at T<sub>A</sub> = 25°C, C<sub>L</sub> = 50 pF, Input t<sub>r</sub>, t<sub>f</sub> = 20 ns, R<sub>L</sub> = 200 k $\Omega$

| Characteristic                                                      | Condit-<br>ions<br>VDD | A                | Units |      |     |
|---------------------------------------------------------------------|------------------------|------------------|-------|------|-----|
| <u> </u>                                                            | (V)                    | Min.             | Тур.  | Max. |     |
| Propagation Delay Time (tpHL, tpLH):                                |                        |                  |       |      | 1   |
|                                                                     | 5                      | . – '            | 200   | 400  |     |
| Clock-to-Q Output (See Fig. 10)                                     | 10                     | — . <sup>1</sup> | 100   | 200  | ns  |
|                                                                     | 15                     | —                | 75    | 150  |     |
|                                                                     | 5                      |                  | 210   | 420  |     |
| Preset or Reset-to-Q Output                                         | 10                     | -                | 105   | 210  | ns  |
|                                                                     | 15                     | -                | 80    | 160  |     |
|                                                                     | 5                      | _                | 240   | 480  |     |
| Clock-to-Carry Out                                                  | 10                     | -                | 120   | 240  | ns  |
|                                                                     | 15                     | -                | 90    | 180  |     |
|                                                                     | 5                      |                  | 125   | 250  | 1   |
| Carry-In-to-Carry Out                                               | 10                     | _                | 60    | 120  | ns  |
| • • •                                                               | 15                     | _                | 50    | 100  | 1   |
|                                                                     | 5                      | -                | 320   | 640  |     |
| Preset or Reset-to-Carry Out                                        | 10                     | _                | 160   | 320  | ns  |
| · · · · ·                                                           | 15                     | -                | 125   | 250  |     |
|                                                                     | 5                      |                  | 100   | 200  |     |
| Transition Time (t <sub>THL</sub> , t <sub>TLH</sub> ) (See Fig. 9) | 10                     |                  | 50    | 100  | ns  |
|                                                                     | 15                     | -                | 40    | 80   |     |
|                                                                     | 5                      | 2                | 4     | -    |     |
| Max. Clock Input Frequency (f <sub>CL</sub> )                       | 10                     | 4                | 8     | - 1  | MHz |
|                                                                     | 15                     | 5.5              | 11    | - 1  |     |
| Input Capacitance (C <sub>IN</sub> )                                |                        |                  | 5     | 7.5  | pF  |
| Set-up Time, ts                                                     | 5                      | 25               | 12    |      | Ť   |
| Preset Enable to Jn                                                 | 10                     | 10               | 6     | _    |     |
|                                                                     | 15                     | 10               | 5     | -    |     |
| Hold times, tH                                                      | 5                      | 60               | 30    |      | 1   |
| Clock to Carry-In                                                   | 10                     | 30               | 4     |      |     |
|                                                                     | 15                     | 30               | 1     | _    | ns  |
|                                                                     | 5                      | 30               | 10    | _    | 1   |
| Clock to Up/Down                                                    | 10                     | 30               | 4     | —    |     |
|                                                                     | 15                     | 30               | 5     | -    |     |
|                                                                     | 5                      | 70               | 35    |      | 1   |
| Preset Enable to J <sub>n</sub>                                     | 10                     | 40               | 20    | _    | l   |
|                                                                     | 15                     | 40               | 20    |      | ł   |





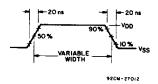


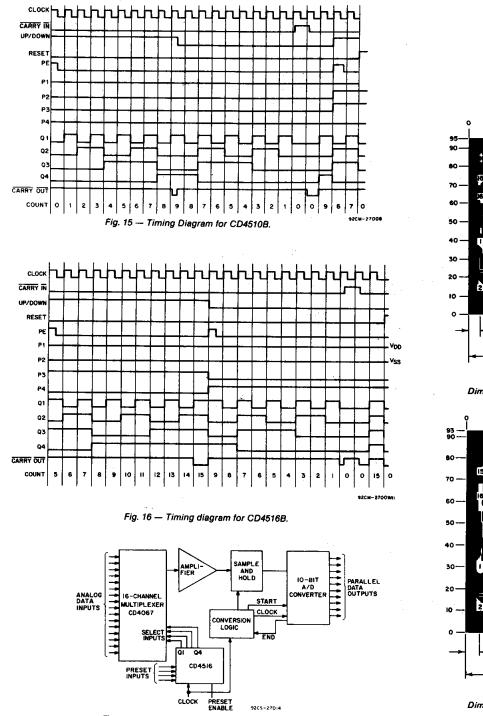
Fig. 14 - Power-dissipation test circuit and input waveform,

CL CI U/D

'X

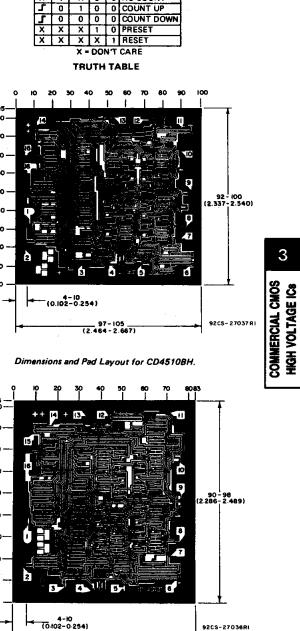
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This acquisition system can be operated in the random access mode by jamming in the channel number at the present inputs, or in the sequential mode by clocking the CD4516B.

Fig. 17 — Typical 16-channel, 10-bit data acquisition system.



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ACTION

0 COUNT UP

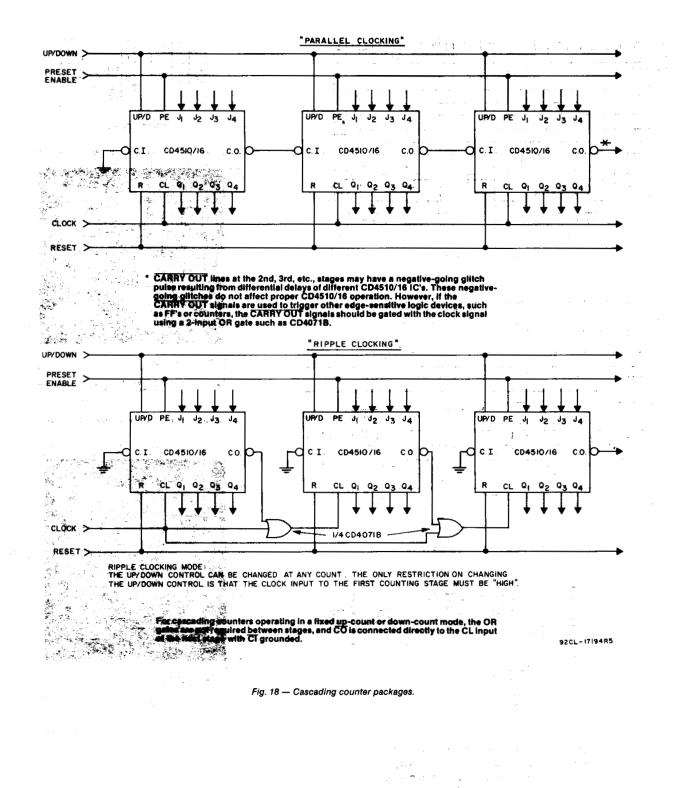
X 0 0 NO COUNT

PE R

Dimensions and Pad Layout for CD4516BH.

80-88\_\_\_\_\_

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3} \text{ inch})$ .



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10-Jun-2014

# PACKAGING INFORMATION

| Orderable Device |        | Package Type |         | Pins | -    | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|----------------|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        | (6)              | (3)                |              | (4/5)          |         |
| CD4510BE         | ACTIVE | PDIP         | N       | 16   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -55 to 125   | CD4510BE       | Samples |
| CD4510BEE4       | ACTIVE | PDIP         | Ν       | 16   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -55 to 125   | CD4510BE       | Samples |
| CD4510BNSR       | ACTIVE | SO           | NS      | 16   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | CD4510B        | Samples |
| CD4510BNSRG4     | ACTIVE | SO           | NS      | 16   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | CD4510B        | Samples |
| CD4510BPWR       | ACTIVE | TSSOP        | PW      | 16   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | CM510B         | Samples |
| CD4516BE         | ACTIVE | PDIP         | N       | 16   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -55 to 125   | CD4516BE       | Samples |
| CD4516BEE4       | ACTIVE | PDIP         | N       | 16   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | -55 to 125   | CD4516BE       | Samples |
| CD4516BF         | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | CD4516BF       | Samples |
| CD4516BF3A       | ACTIVE | CDIP         | J       | 16   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | CD4516BF3A     | Samples |
| CD4516BNSR       | ACTIVE | SO           | NS      | 16   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | CD4516B        | Samples |
| CD4516BPW        | ACTIVE | TSSOP        | PW      | 16   | 90   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | CM516B         | Samples |
| CD4516BPWR       | ACTIVE | TSSOP        | PW      | 16   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -55 to 125   | CM516B         | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.



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# PACKAGE OPTION ADDENDUM

10-Jun-2014

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF CD4516B, CD4516B-MIL :

• Catalog: CD4516B

• Military: CD4516B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal<br>Device | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD4510BNSR                            | SO              | NS                 | 16 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| CD4510BPWR                            | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| CD4516BNSR                            | SO              | NS                 | 16 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| CD4516BPWR                            | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

4-Nov-2017



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4510BNSR | SO           | NS              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| CD4510BPWR | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD4516BNSR | SO           | NS              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| CD4516BPWR | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |

### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  $\beta$ . This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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